



MAIL STOP AF  
RESPONSE UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 1700

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J.-S. Mok et al.

Attorney Docket No.: LEPA121687

Application No.: 10/677,182

Art Unit: 1765 / Confirmation No: 8329

Filed: October 2, 2003

Examiner: S. Ahmed

Title: METHOD OF FORMING SOLDER RESIST PATTERN

AMENDMENT AFTER FINAL REJECTION

Seattle, Washington 98101

November 22, 2006

TO THE COMMISSIONER FOR PATENTS:

Please amend the above-identified application as follows.

OK to  
enforce  
SA  
12/13/06